

MOSFET

OptiMOS[™]5 Power-Transistor, 80 V

Features

- Optimized for low voltage motor drives application
 Optimized for battery powered applications
 Enables automated optical solder inspection
 100% avalanche tested

- N-channel
- 175°C rated
- Pb-free lead plating : RoHS compliant

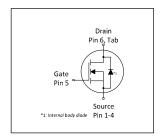
Product validation

Fully qualified according to JEDEC for Industrial Applications

Key Performance Parameters Table 1

Parameter	Value	Unit					
V _{DS}	80	V					
R _{DS(on),max}	1.9	$m\Omega$					
I _D	290	A					
Q _{oss}	112	nC					
Q _G (0V10V)	94	nC					











Type / Ordering Code	Package	Marking	Related Links
IST019N08NM5	sTOLL	019N08N5	-

OptiMOSTM5 Power-Transistor, 80 V IST019N08NM5



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OptiMOS[™]5 Power-Transistor, 80 V IST019N08NM5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatav	Complete I	Values			11	N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	-	- - -	290 205 32	A	V _{GS} =10 V, T _C =25 °C V _{GS} =10 V, T _C =100 °C V _{GS} =10 V, T _A =25 °C, R _{THJA} =40 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1160	А	T _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	345	mJ	$I_{\rm D}$ =100 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	313 3.8	W	T _C =25 °C T _A =25 °C, R _{THJA} =40 °C/W ²)
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Doromotor	Symbol	Values			l lmi4	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R_{thJC}	-	0.3	0.48	°C/W	-
Device on PCB, 6 cm² cooling area	R _{thJA}	-	-	40	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25°C. For higher case temperature please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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Electrical characteristics

at T_j=25 °C, unless otherwise specified

Static characteristics Table 4

Dougnates:	Currele el		Values			N 4 4 7 4 9 4 199	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	80	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2.2	-	3.8	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 148 \ \mu {\rm A}$	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1	μΑ	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	1.6 2.2	1.9 2.85	mΩ	V _{GS} =10 V, I _D =100 A V _{GS} =6 V, I _D =50 A	
Gate resistance ¹⁾	R _G	-	0.9	-	Ω	-	
Transconductance	g_{fs}	125	190	-	S	V _{DS} ≥2 / _D R _{DS(on)max} , / _D =100 A	

Table 5 **Dynamic characteristics**

Parameter	Complete all	Values			11	Note (Total Constitution
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	C _{iss}	-	6600	-	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Output capacitance	Coss	_	1100	-	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Reverse transfer capacitance	C _{rss}	-	48	-	рF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	24	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,exi}$ =1.6 Ω
Rise time	t _r	-	29	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	43	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t_{f}	-	10	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Symbol	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Offic	Note / Test Condition
Gate to source charge	Q _{gs}	-	31	-	nC	V _{DD} =40 V, I _D =100 A, V _{GS} =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	20	-	nC	V _{DD} =40 V, I _D =100 A, V _{GS} =0 to 10 V
Gate to drain charge	$Q_{ m gd}$	-	20	-	nC	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V
Switching charge	Q _{sw}	-	32	-	nC	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate charge total ¹⁾	Q_g	-	94	132	nC	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.7	-	V	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate charge total, sync. FET	$Q_{g(sync)}$	-	81	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge	Qoss	-	112	-	nC	V _{DS} =40 V, V _{GS} =0 V

Defined by design. Not subject to production test.
See "Gate charge waveforms" for parameter definition

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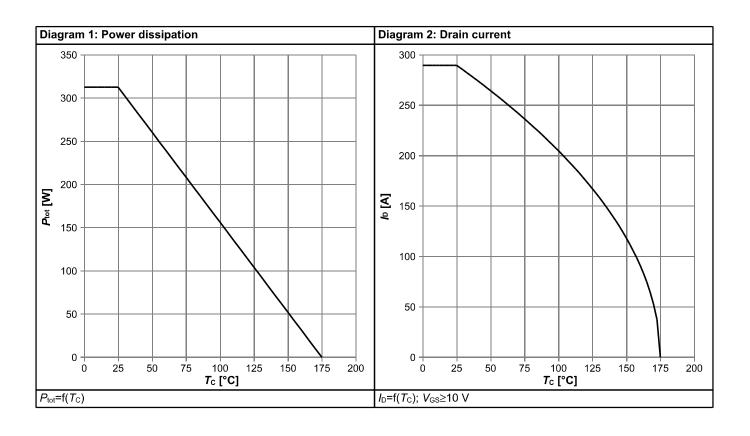


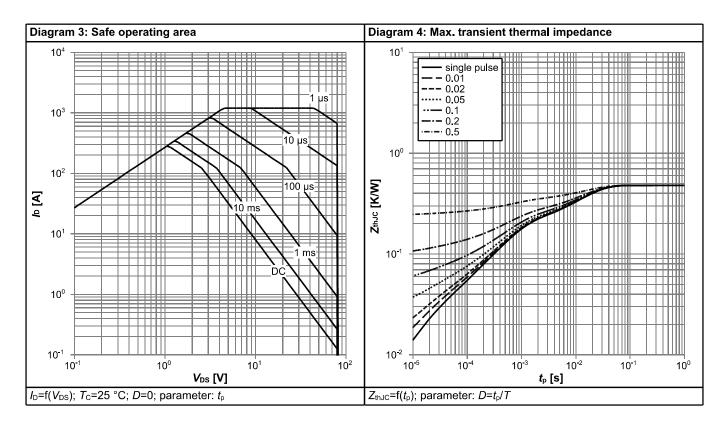
Table 7 Reverse diode

Douglaston	Comple al		Values			Nata / Taat Oan ditian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	245	Α	T _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	1160	Α	T _C =25 °C	
Diode forward voltage	V _{SD}	-	0.9	1.1	V	V _{GS} =0 V, I _F =100 A, T _j =25 °C	
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	49	-	ns	V _R =40 V, I _F =100 A, d <i>i</i> _F /d <i>t</i> =100 A/μs	
Reverse recovery charge ¹⁾	Q _{rr}	-	66	-	nC	V _R =40 V, I _F =100 A, di _F /dt=100 A/µs	

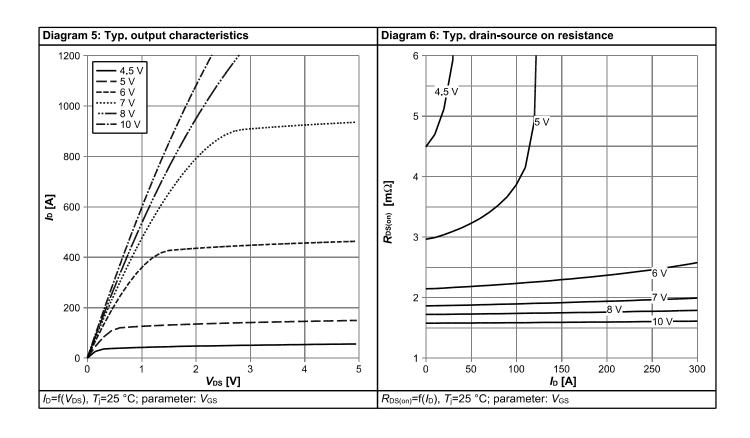


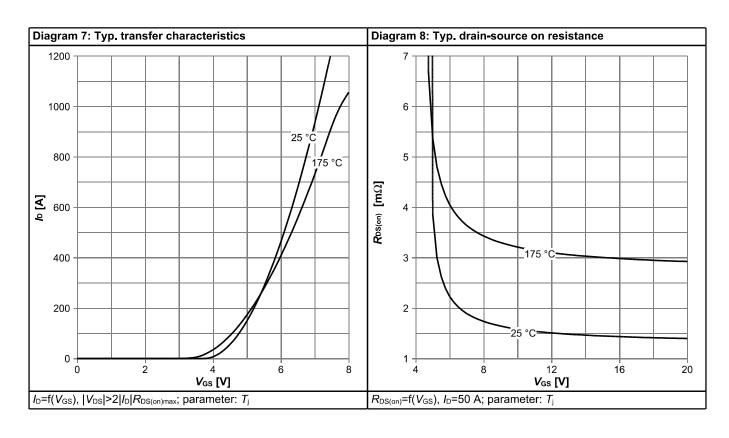
4 Electrical characteristics diagrams



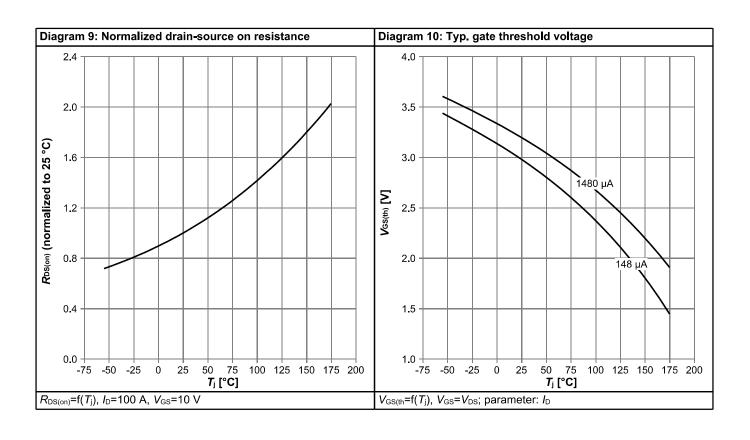


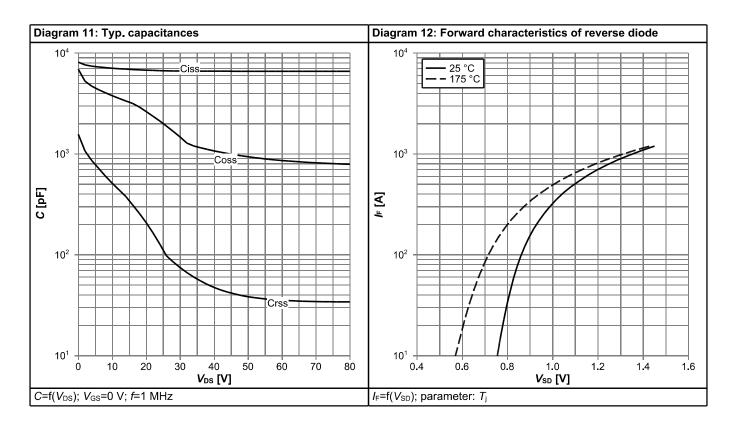




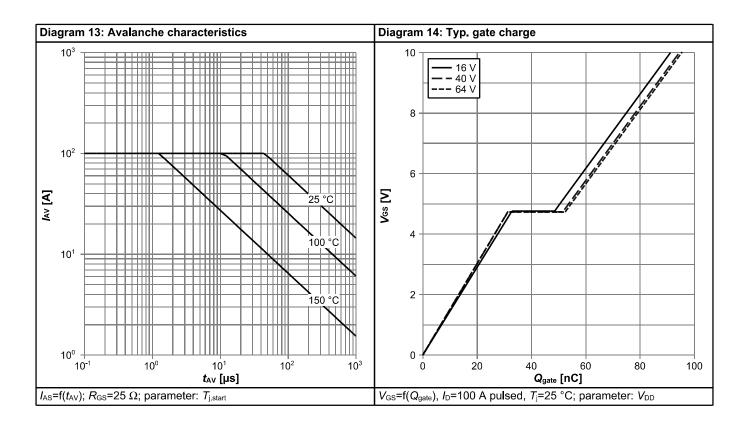


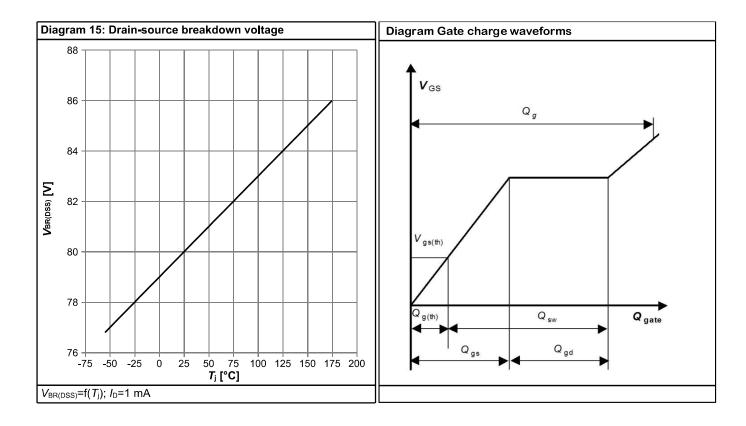














5 Package Outlines

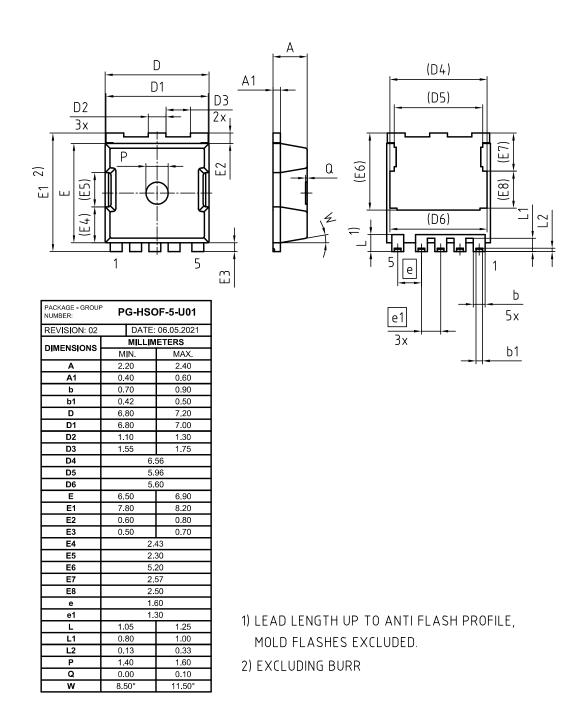


Figure 1 Outline sTOLL, dimensions in mm

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Revision History

IST019N08NM5

Revision: 2022-01-24, Rev. 2.1

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2020-11-20	Release of final version				
2.1	2022-01-24	Update Part Marking				

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